



# Silicon MELF 500 mW Zener Diodes

Qualified per MIL-PRF-19500/127

**Qualified Levels:** JAN, JANTX, and **JANTXV** 

#### **DESCRIPTION**

This popular series of 500 mW Zener voltage regulators provides a selection from 2.4 to 12 volts in a standard 5% tolerance as well as available tighter 2% and 1% tolerances. These glass, surface mount DO-213AA Zeners feature an internal metallurgical bond and are military qualified to the JAN, JANTX, and JANTXV level. A RoHS compliant commercial grade only version is also available.

**Important:** For the latest information, visit our website http://www.microsemi.com.

## **FEATURES**

- JEDEC registered 1N746 through 1N759A and 1N4370 through 1N4372A series.
- Standard voltage tolerance is  $\pm$  5% with optional tighter tolerances of  $\pm$  2% or 1%.
- Internal metallurgical bond.
- JAN, JANTX, and JANTXV qualifications are available per MIL-PRF-19500/127. (See part nomenclature for all available options.)
- RoHS compliant versions available (commercial grade only).
- These commercial surface mount equivalents were also previously identified with a CDLL or MLL prefix instead of the "1N" prefix.

#### **APPLICATIONS / BENEFITS**

- Regulates voltage over a broad range of temperature and current.
- Regulated voltage range from 2.4 to 12 V.
- Small size for high density mounting using the surface mount method (see package illustration).
- Non-sensitive to ESD per MIL-STD-750 method 1020.
- Minimal capacitance.
- Inherently radiation hard as described in Microsemi MicroNote 050.

#### **MAXIMUM RATINGS**

Parameters/Test Conditions	Symbol	Value	Unit
Operating and Storage Temperature	T <sub>J</sub> and T <sub>STG</sub>	-65 to +175	°C
Thermal Resistance Junction-to-End Cap	$R_{\Theta JEC}$	100	∘C/W
Thermal Resistance Junction-to-Ambient when mounted on PCB <sup>(1)</sup>	R <sub>OJA</sub>	300	°C/W
Average Rated Power Dissipation  @ $T_{EC} = +125^{\circ}C^{(2)}$ @ $T_A = 55^{\circ}C$ mounted on PCB	P <sub>M(AV)</sub>	0.5 0.4	W
Forward Voltage @ I <sub>F</sub> = 200 mA	V <sub>F</sub>	1.1	V
Solder Temperature @ 10 s		260	°C

- **NOTES:** 1. See Figure 1 for derating curves.  $T_A = +75$  °C on an FR4 PC board with 1 oz copper metalization.
  - 2. The 0.5 W linearly derates starting at  $T_{EC} = 125$  °C and goes to zero at 175 °C. For ambient  $T_A$ condition on a typical PC board, it linearly derates from 400 mW starting at 55 °C and goes to zero at 175 °C (see Figure2).

## **DO-213AA MELF Package**

Also available in:

DO-35 (DO-204AH) package

(axial-leaded) 1N746A-1 -1N759A-1 and 1N4370A-1 -1N4372A-1

#### MSC - Lawrence

6 Lake Street. Lawrence, MA 01841 Tel: 1-800-446-1158 or (978) 620-2600 Fax: (978) 689-0803

#### MSC - Ireland

Gort Road Business Park, Ennis, Co. Clare, Ireland Tel: +353 (0) 65 6840044 Fax: +353 (0) 65 6822298

#### Website:

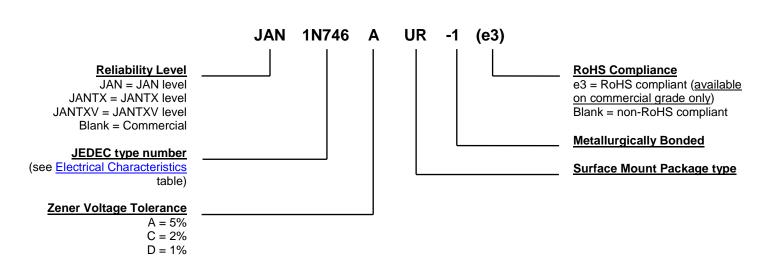
www.microsemi.com



## **MECHANICAL and PACKAGING**

- CASE: Hermetically sealed glass case package.
- TERMINALS: Tin/lead plated or RoHS compliant matte-tin (on commercial grade only) over copper clad steel. Solderable per MIL-STD-750, method 2026.
- · POLARITY: Cathode end is banded.
- MOUNTING: The axial coefficient of expansion (COE) of this device is approximately +6PPM/°C. The COE of the mounting surface system should be selected to provide a suitable match with this device.
- · MARKING: Part number.
- TAPE & REEL option: Standard per EIA-296. Consult factory for quantities.
- · WEIGHT: Approximately 0.04 grams.
- See <u>Package Dimensions</u> on last page.

#### PART NOMENCLATURE



SYMBOLS & DEFINITIONS			
Symbol	Definition		
I <sub>R</sub>	Reverse Current: The maximum reverse (leakage) current that will flow at the specified voltage and temperature.		
$I_Z$ , $I_{ZT}$ , $I_{ZK}$	Regulator Current: The dc regulator current $(I_z)$ , at a specified test point $(I_{ZT})$ , near breakdown knee $(I_{ZK})$ .		
I <sub>ZM</sub>	Maximum Regulator (Zener) Current: The maximum rated dc current for the specified power rating.		
I <sub>ZSM</sub>	Maximum Zener Surge Current: The non-repetitive peak value of Zener surge current at a specified wave form.		
V <sub>F</sub>	Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current.		
V <sub>R</sub>	Reverse Voltage: The reverse voltage dc value, no alternating component.		
Vz	Zener Voltage: The Zener voltage the device will exhibit at a specified current (I <sub>Z</sub> ) in its breakdown region.		
$Z_{ZT}$ or $Z_{ZK}$	Dynamic Impedance: The small signal impedance of the diode when biased to operate in its breakdown region at a specified rms current modulation (typically 10% of I <sub>ZT</sub> or I <sub>ZK</sub> ) and superimposed on I <sub>ZT</sub> or I <sub>ZK</sub> respectively.		



## **ELECTRICAL CHARACTERISTICS** @ 25 °C

JEDEC TYPE NO. (NOTE 1)	NOMINAL ZENER VOLTAGE V <sub>Z</sub> @ I <sub>ZT</sub>	MAXIMUM ZENER IMPEDANCE Z <sub>ZT</sub> @ I <sub>ZT</sub>	REVERSE VOLTAGE V <sub>R</sub>	MAXIMUM REVERSE CURRENT I <sub>R</sub> @ V <sub>R</sub>		CURRENT		MAXIMUM ZENER CURRENT I <sub>ZM</sub>	TEMPERATURE COEFFICIENT OF ZENER VOLTAGE
(NOTE I)	(NOTE 2)	(NOTE 3)		@ 25 °C	@ +150 °C	(NOTE 4)	α <sub>vz</sub>		
	Volts	Ohms	Volts	μA	μA	mA	% / °C		
1N4370A-1	2.4	30	1.0	100	200	155	-0.085		
1N4371A-1	2.7	30	1.0	60	150	140	-0.080		
1N4372A-1	3.0	29	1.0	30	100	125	-0.075		
1N746A-1	3.3	24	1.0	5	30	120	-0.070		
1N747A-1	3.6	22	1.0	3	30	110	-0.065		
1N748A-1	3.9	20	1.0	2	30	100	-0.060		
1N749A-1	4.3	18	1.0	2	50	90	-0.055 / +.020		
1N750A-1	4.7	15	1.5	5	50	85	-0.043 / +.025		
1N751A-1	5.1	14	2.0	5	50	75	-0.030 / +.030		
1N752A-1	5.6	8	2.5	5	50	70	-0.028 / +.036		
1N753A-1	6.2	3	3.5	5	50	65	+0.045		
1N754A-1	6.8	3	4.0	2	50	60	+0.050		
1N755A-1	7.5	4 5	5.0	2	50	55	+0.058		
1N756A-1	8.2	5	6.0	1	50	50	+0.062		
1N757A-1	9.1	6	7.0	1	50	45	+0.068		
1N758A-1	10.0	7	8.0	1	50	40	+0.076		
1N759A-1	12.0	10	9.0	1	50	35	+0.080		

#### NOTES:

- 1 The JEDEC type numbers shown (A suffix) have a ± 5% tolerance on nominal Zener voltage.
- 2. Voltage measurements to be performed 20 seconds after application of dc test current.
- Zener impedance derived by superimposing on I<sub>ZT</sub>, a 60 cps, rms current equal to 10% I<sub>ZT</sub> (20 mA). See MicroNote 202 for typical Zener Impedance variation with different operating currents.
- 4. Allowance has been made for the increase in V<sub>Z</sub> due to Z<sub>Z</sub> and for the increase in junction temperature as the unit approaches thermal equilibrium at the power dissipation of 400mW.



## **GRAPHS**

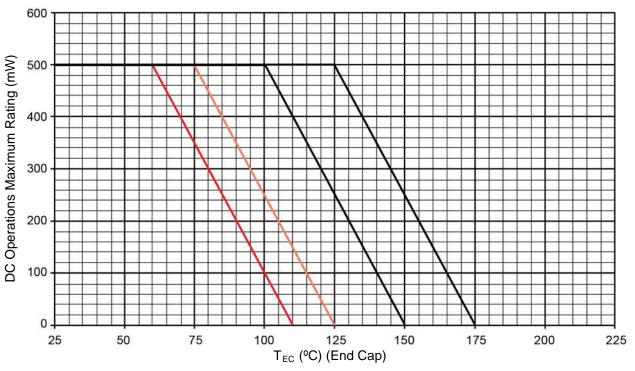
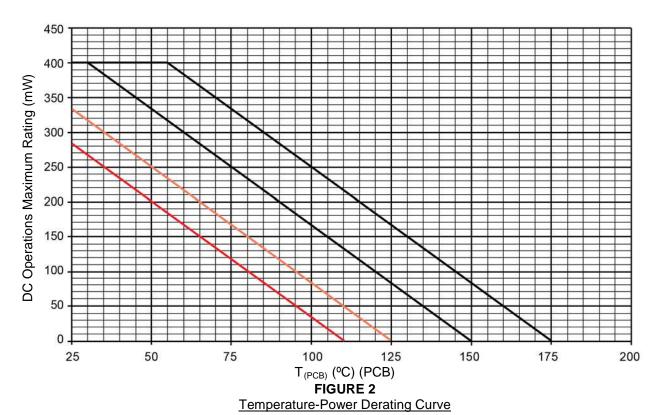


FIGURE 1
Temperature-Power Derating Curve





## **GRAPHS** (continued)

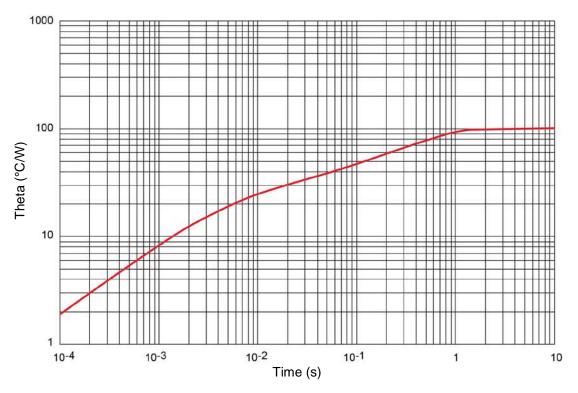
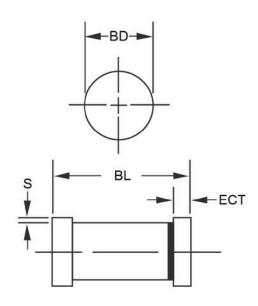


FIGURE 3
Thermal Impedance To End Cap



## **PACKAGE DIMENSIONS**

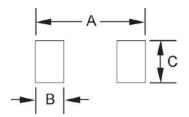


DIM	INCH		MILLIMETERS		
DIIVI	MIN	MAX	MIN	MAX	
BD	0.063	0.067	1.60	1.70	
BL	0.130	0.146	3.30	3.71	
ECT	0.016	0.022	0.41	0.56	
S	0.001 min		0.03 min		

## NOTES:

- 1. Dimensions are in inches. Millimeters are given for information only.
- 2. Dimensions are pre-solder dip.
- 3. Referencing to dimension S, minimum clearance of glass body to mounting surface on all orientations.
- 4. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.

## PAD LAYOUT



	INCH	mm
Α	0.200	5.08
В	0.055	1.40
С	0.080	2.03